



Product Change Notification

Change Notification #: 118674-00
Change Title: Select Intel® Server System R1304WFTYSR,
PCN 118674-00, Product Design,
Adding a Gasket to avoid ESD scenarios
Date of Publication: November 12, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *	December 10, 2021
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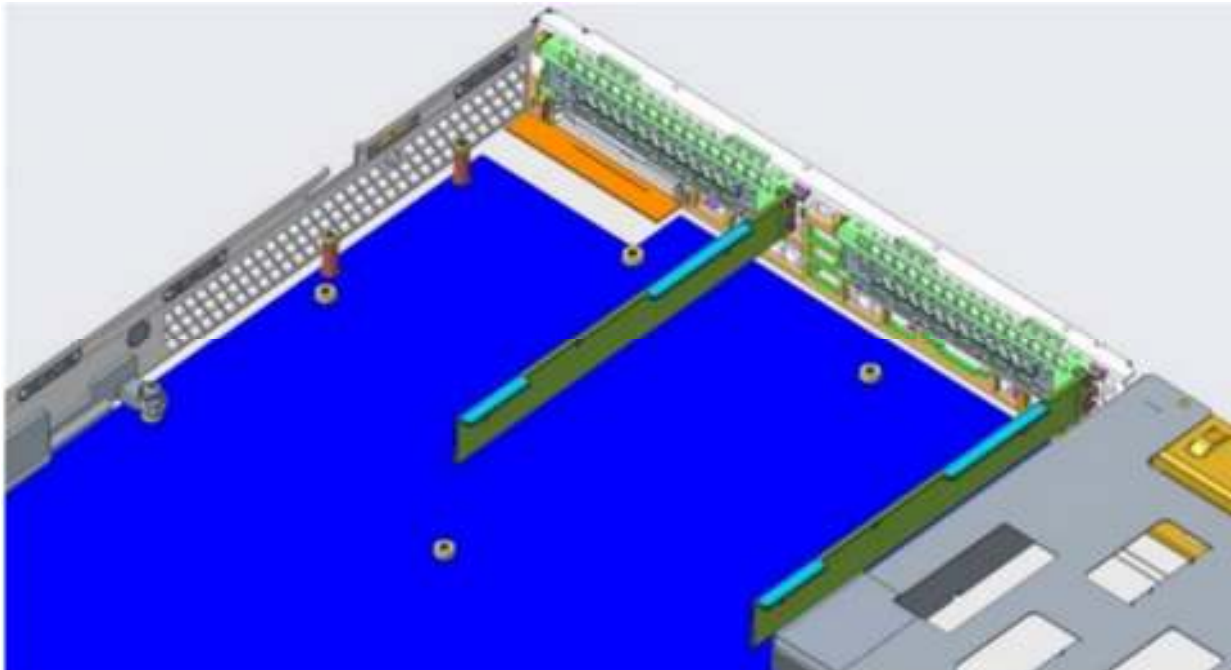
* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

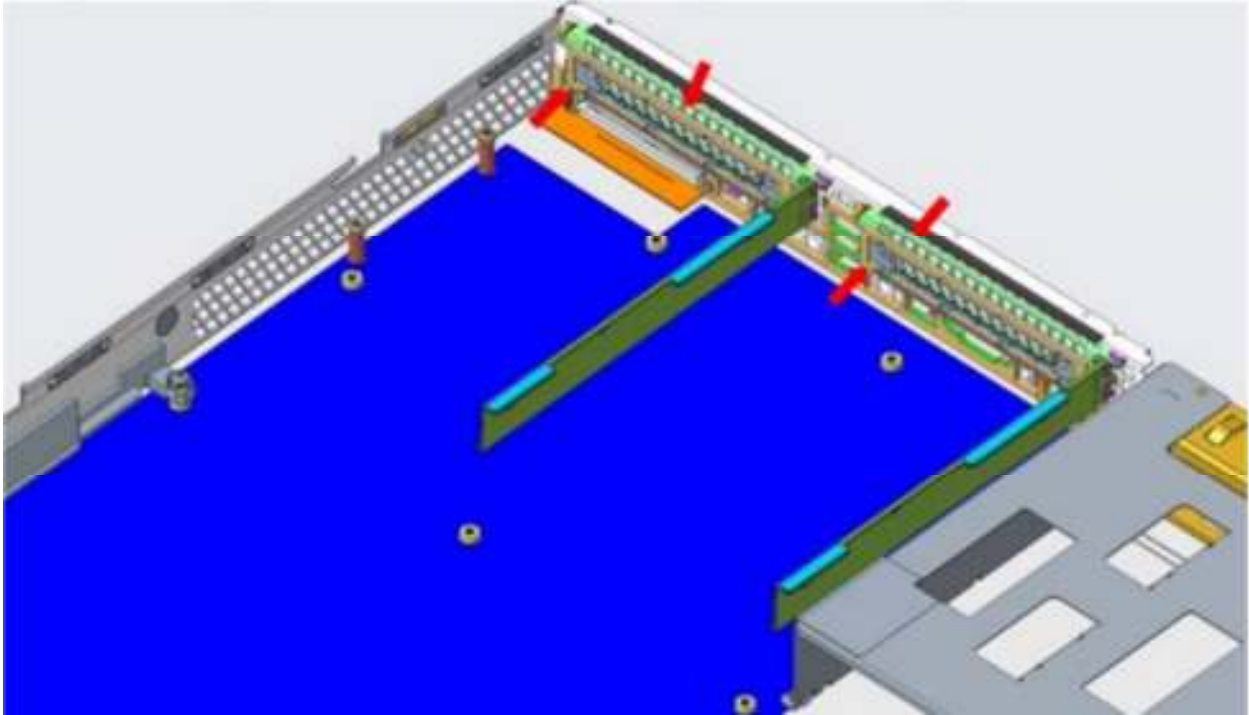
Intel is adding a bracket on the gasket to avoid ESD scenarios on the intel Server System listed in the "Products Affected" table.

Pictures are for example only

Before



After



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server System R1304WFTYSR	R1304WFTYSR	986048	K39979-009	K39979-010

PCN Revision History:

Date of Revision:
November 12, 2021

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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